mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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			F	irst Edition Jul 22, 2003
L	CD Module	Technica	I Specification	inal Revision
Туре No	F-514050	ANB-LW-A	J	
			Approved by (Quality As Checked by (ACI En R Wague Prepared by (Module Adm	gineering Division)
1. 2. 3. 4. 5.	Electrical Specification Optical Specifications I/O Terminal Test	s ns		3 11 13 16
8. 9. 10 11	Type Number Applying Precautions Precautions Relating	Product Handling		20 20 21
Rev.	Date	Page Com	ment	
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1.General Specifications

Operating Temp.	:	min. 0°C ~max. 50°C					
Storage Temp.	:	min20°C ~max. 70°C					
Dot Pixels	:	240 (W) × 64 (H) dots					
Dot Size	:	0.51 (W) × 0.51 (H) mm					
Dot Pitch	:	0.53 (W) × 0.53 (H) mm					
Viewing Area	:	130.2 (W) × 36.7 (H) mm					
Outline Dimensions	:	149.5 (W) × 51.7* (H) × 9.8max.** (D) mm *Without LED Cable and Flat Cable **Without Hook					
Weight	:	95g max.					
LCD Type	:	NTD-21409 (STN / Blue-mode / Transmissive)					
Viewing Angle	:	6:00					
Data Transfer	:	8-bit parallel data transfer					
Backlight	:	LED Backlight / White					
Drawings	:	Dimensional Outline UE-311744					

2.Electrical Specifications

2.1. Absolute Maximum Ratings

2.1.7.60010101		95			Vss=0V
Parameter	Symbol	Conditions	Min.	Max.	Units
Supply Voltage (Logic)	VDD-VSS	-	-0.3	7.0	V
Supply Voltage	Vss2	With Double *1	-7.0	+0.3	V
(Booster Circuit)		With Triple *1	-6.0	+0.3	
		With Quad *1	-4.5	+0.3	
Supply Voltage 1 (LCD Drive)	V5, Vout	*1	-18.0	+0.3	V
Supply Voltage 2 (LCD Drive)	V1, V 2, V 3, V 4	*1	V 5	+0.3	V
Input Voltage	Vin	-	-0.3	Vdd+0.3	V
Output Voltage	Vouт	-	-0.3	Vdd+0.3	V

*1 Relative to VDD.

2.2. DC Characteristics

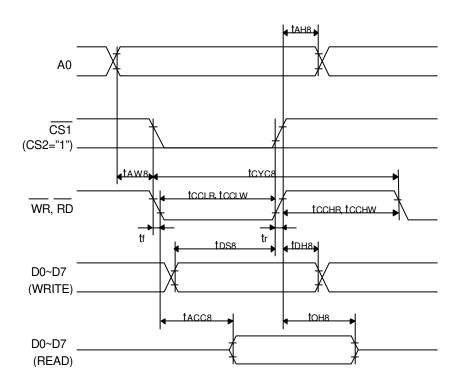
	-					Та	=25°C, '	Vss=0V
Parameter	Symbol	Conditions	5	Min.	Тур.	N	lax.	Units
Supply Voltage	Vdd-Vss	-		4.5	-	!	5.5	V
(Logic)								
Supply Voltage	V 5	*1		-16.0	-	-	4.5	V
(LCD Drive)	V1, V 2	*1		0.4×V5	-	١	/DD	V
	V 3, V 4	*1		V 5	-	0.	6×V5	V
Supply Voltage	Vss2	With Triple	*1	-6.0	-	-	1.8	V
(Booster Circuit)		With Quad	*1	-4.5	-	-	1.8	
Booster Output	Vout	*1		-18.0	-		-	V
Voltage								
Voltage Regulator	Vout	*1		-18.0	-	-	6.0	V
Operating Voltage								
Voltage Follower	V 5	*1		-16.0	-	-	4.5	V
Operating Voltage								
Base Voltage	VREG0	-0.05%/°C *1		-2.04	-2.10	-2	2.16	V
	VREG1	-0.20%/°C *1		-4.65	-4.90	-{	5.15	V
"High" Level	Vін	-		0.8×Vdd	-	\	/DD	V
Input Voltage								
"Low" Level	VIL	-		Vss	-	0.2	×Vdd	V
Input Voltage								
"High" Level	Vон	юн=-0.5mA		0.8×Vdd	-	۱ N	/DD	V
Output Voltage								
"Low" Level	Vol	lo∟=0.5mA		Vss	-	0.2	×Vdd	V
Output Voltage								
	ldd	VDD-VSS=5.0V		-	2.6	;	3.9	mA
Supply Current								
	5	VDD-VSS=12.4V		-	0.2		0.3	mA
*1 Relative to VDD.								
		2002 0122					De	ao 2/00
F-51405GNB-LW	-AJ (AJ) NO.	2003-0122		OPTREX COP	FURATION		Pa	ge 3/22

Ta=25°C, Vss=0V

2.3.AC Characteristics

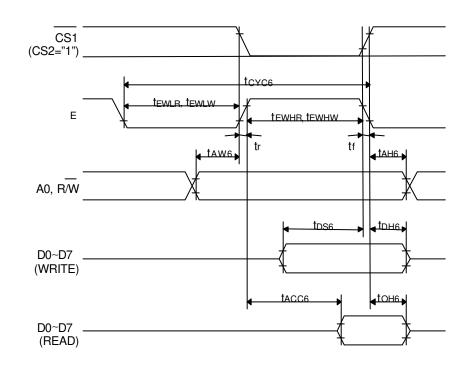
2.3.1. Read/Write Operation Sequence (80 series CPU)

·	I	()		Vdd	=5.0V±10%
Parameter		Symbol	Min.	Max.	Units
Address Setup Time		t _{AW8}	0	-	ns
Address Hold Time		t _{AH8}	0	-	ns
System Cycle Time		t _{CYC8}	166	-	ns
Control Low Pulse Width	WRITE	t _{CCLW}	30	-	ns
	READ	t _{CCLR}	70	-	ns
Control High Pulse Width	WRITE	t _{сснw}	30	-	ns
	READ	t cchr	30	-	ns
Data Setup Time		t _{DS8}	30	-	ns
Data Hold Time		t _{DH8}	10	-	ns
RD Access Time		t _{ACC8}	-	70	ns
Output Disable Time		t _{OH8}	5	50	ns



2.3.2. Read/Write Operation Sequence (68 series CPU)

	-			Vdd	=5.0V±10%
Parameter	Symbol	Min.	Max.	Units	
Address Setup Time		t _{AH6}	0	-	ns
Address Hold Time		t _{aw6}	0	-	ns
System Cycle Time		t _{CYC6}	166	-	ns
Data Setup Time		t_{DS6}	30	-	ns
Data Hold Time		t _{DH6}	10	-	ns
Access Time (CL=100pF)		t _{ACC6}	-	70	ns
Output Disable Time		t _{oн6}	10	50	ns
Enable High Pulse Width	READ	t ewhr	70	-	ns
	WRITE	t _{еwнw}	30	-	ns
Enable Low Pulse Width	READ	t _{EWLR}	30	-	ns
	WRITE	t _{ewlw}	30	-	ns



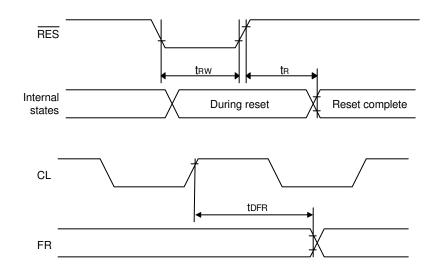
2.3.3. Display Control Timing Characteristics

Reset Input TimingVDD=5.0±10%								
Parameter	Symbol	Min.	Тур.	Max.	Units			
Reset time	t _R	-	-	0.5				
Reset "L" Pulse Width	t _{RW}	0.5	-	-	μs			

Output Timing VDD=5.0±10%						
Parameter	Symbol	Min.	Тур.	Max.	Units	
FR Delay Time	t _{deb}	-	10	40	ns	

Note 1 :Valid only when the master mode is selected.

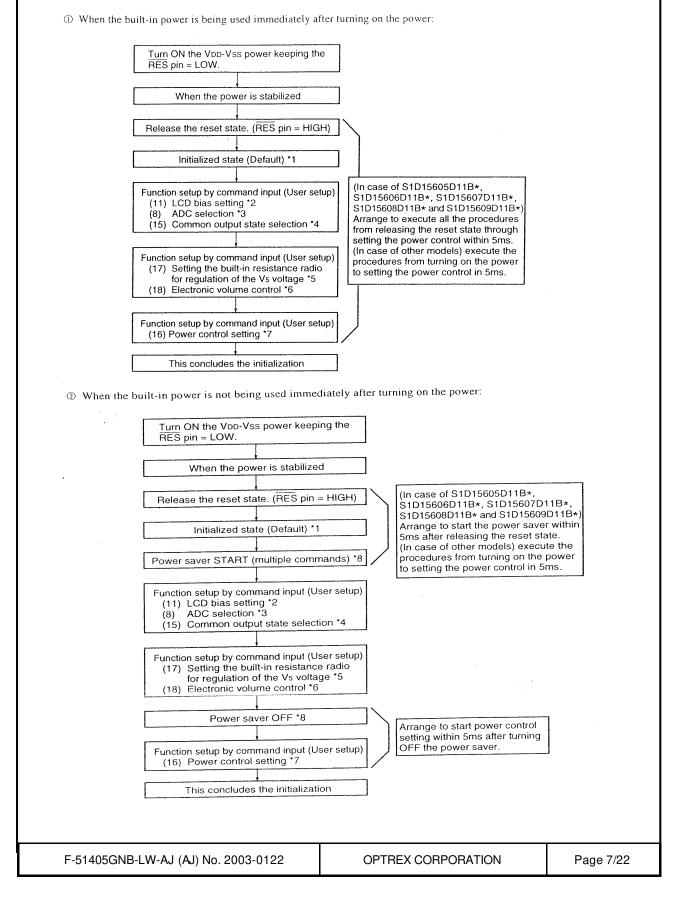
Note 2:All timing is based on 20% and 80% of Vss.

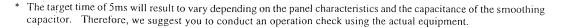


Instruction Setup: Reference (reference)

(1) Initialization

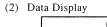
Note: With this IC, when the power is applied, LCD driving non-selective potentials V₂ and V₃ (SEG pin) and V₁ and V₄ (COM pin) are output through the LCD driving output pins SEG and COM. When electric charge is remaining in the smoothing capacitor connecting between the LCD driving voltage output pins (V₁ ~ V₅) and the VDD pin, the picture on the display may become totally dark instantaneously when the power is turned on. To avoid occurrence of such a failure, we recommend the following flow when turning on the power.

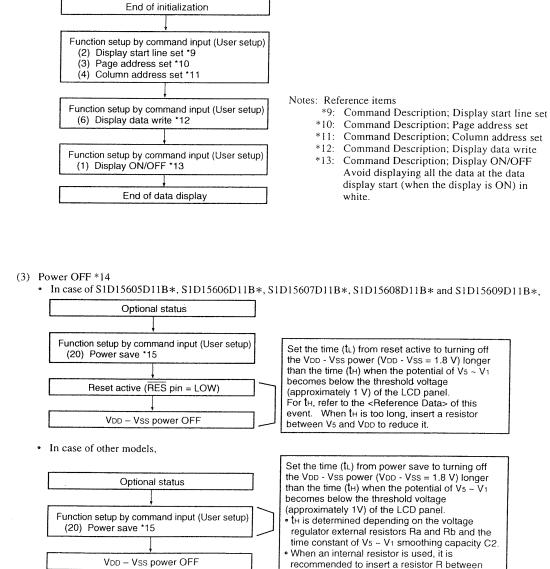




Notes: Refer to respective sections or paragraphs listed below.

- *1: 6. Description of functions; "Resetting circuit" (The contents of DDRAM can be variable even in the initial setting (Default) at the reset state.)
- *2: 7. Command description; "(11) LCD bias setting"
- *3: 7. Command description; "(8) ADC selection'
- *4: 7. Command description; "(15) Common output state selection"
- *5: 6. Description of functions; "Power circuit" & "(17) Command description; Setting the built-in resistance radio for regulation of the V5 voltage'
- *6: 6. Description of functions; "Power circuit" & "(18) Command description; Electronic volume control"
 *7: 6. Description of functions; "Power circuit" & "(16) Command description; Power control setting" *8: 7. The power saver ON state can either be in sleep state or stand-by state.
- Command description; "Power saver START (multiple commands)"





Notes: Reference items

*14: The logic circuit of this IC's power supply VDD - Vss controls the driver of the LCD power supply VDD - V5. So, if the power supply VDD - VSS is cut off when the LCD power supply VDD - V5 has still any residual voltage, the driver (COM. SEG) may output any uncontrolled voltage. When turning off the power, observe the following basic procedures: After turning off the internal power supply, make sure that the potential V5 ~ V1 has become below the threshold voltage of the LCD panel, and then turn off this IC's power supply (VDD - VSS). 6. Description of Function, 6.7 Power Circuit *15: After inputting the power save command, be sure to reset the function using the RES terminal until the power supply VDD - VSS is turned off. 7. Command Description (20) Power Save After inputting the power save command, do not reset the function using the RES terminal until the power supply VDD - VSS is turned off. 7. Command Description (20) Power Save *16

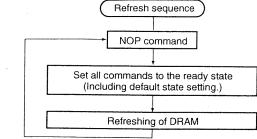
VDD and Vs to reduce th.

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(4) Refresh

It is recommended that the operating modes and display contents be refreshed periodically to prevent the effect of unexpected noise.



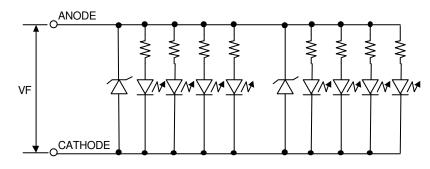
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2.4. Lighting Specifications

2.4.1. Absolute Maximum Ratings

						Ta=25°C
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Voltage	VF	Note 1	-	-	5.5	V
LED Power Dissipation	PD	-	-	-	1100	mW

Note 1 : VF is defined as the voltage between ANODE and CATHODE as shown below.



2.4.2. Operating Characteristics

						Ta=25°C
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Foward Current	lF	Vf= 5.0 V	-	120	200	mA
Luminance of	L	Vf= 5.0 V	400	-	-	cd/m ²
Backlight Surface						

000

3. Optical Specifications

3.1.LCD Driving Voltage

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Recommended		Ta= 0°C	-	-	13.8	V
LCD Driving Voltage	Vdd-V5	Ta=25°C	11.5	12.4	13.3	V
Note 1		Ta=50°C	10.8	-	-	V

Note 1 : Voltage (Applied actual waveform to LCD Module) for the best contrast. The range of minimum and maximum shows tolerance of the operating voltage. The specified contrast ratio and response time are not guaranteed over the entire range.

3.2. Optical Characteristics

Ta=25°C, 1/65 Duty, 1/9 Bias, Von=12.4V (Note 4), θ= 0°, φ=270°

Pa	rameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Contrast Ra	atio Note 1	CR	θ= 0°C , φ=270°	-	5.5	-	
Viewing An	gle		Shown in 3.3				
Response	Rise Note 2	Ton	-	-	100	200	ms
Time	Decay Note 3	Toff	-	-	130	200	ms

Note 1 :Contrast ratio is definded as follows. (CR = LON / LOFF)

LON : Luminance of the ON segments

LOFF: Luminance of the OFF segments

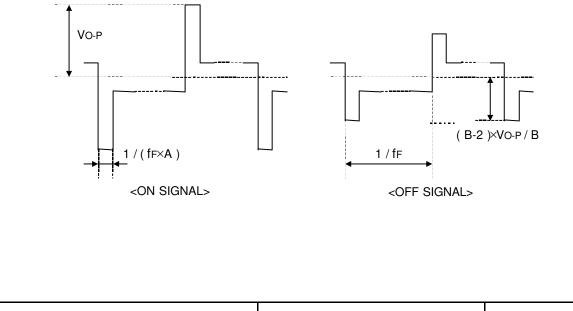
Measuring Spot : 3.0mm

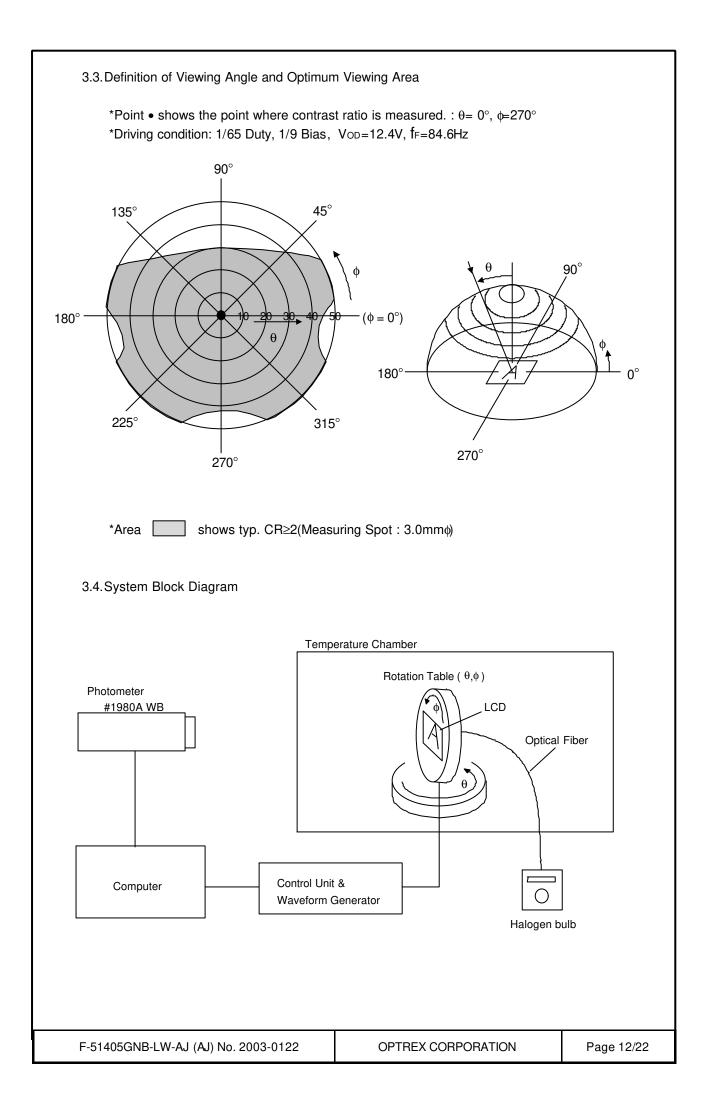
Note 2 :The time that the luminance level reaches 90% of the saturation level from 0% when ON signal is applied.

Note 3 :The time that the luminance level reaches 10% of the saturation level from 100% when OFF signal is applied.

Note 4 :Definition of Driving Voltage VoD

Assuming that the typical driving waveforms shown below are applied to the LCD Panel at 1/A Duty - 1/B Bias (A: Duty Number, B: Bias Number). Driving voltage VoD is definded as the voltage Vo-P when the contrast ratio (CR=LON / LOFF) is at its maximum.





4.I/O Terminal

4.1.Pin Assignment

<u>CN1</u> <u>CN2</u>

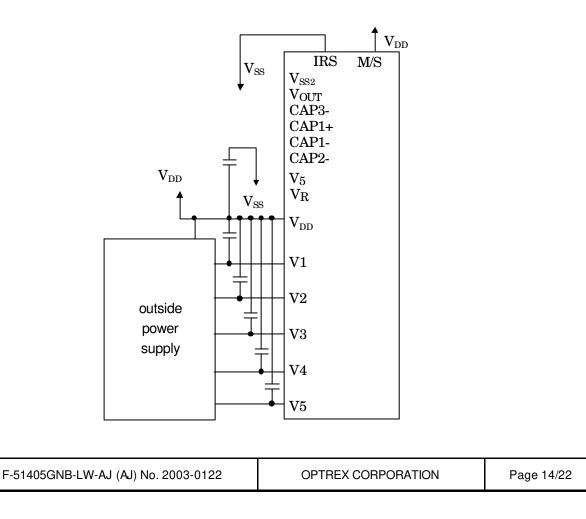
No.	Symbol	Function			
1	NC	Non-connection			
2	FR	Input/Output for LCD AC Drive			
3	CL	Input for Display Clock			
4	DOF	LCD Blanking Control Terminal			
5	CS1	Chip Select Signal L : Active			
6	CS2	Chip Select Signal H : Active			
7	RES	Reset Signal L : Reset			
8	A0	H: D0~D7 are Display Data L: D0~D7 are Instructions			
9	WR	80 family CPU : Write Signal L : Active			
	(R/W)	68 family CPU : Read/Write Select Signal H : Read			
10	RD	80 family CPU : Read Signal L : Active			
	(E)	68 family CPU : Enable Signal H : Active			
11	D0	Display Data			
12	D1	Display Data			
13	D2	Display Data			
14	D3	Display Data			
15	D4	Display Data			
16	D5	Display Data			
17	D6	Display Data			
18	D7	Display Data			
19	Vdd	Power Supply for Logic			
20	Vss	Power Supply(0V, GND)			
21	Vout	DC/DC Voltage Converter Output			
22	CAP3-	DC/DC Voltage Converter Negative Connection			
23	CAP1+	DC/DC Voltage Converter Positive Connection			
24	CAP1-	DC/DC Voltage Converter Negative Connection			
25	CAP2-	DC/DC Voltage Converter Negative Connection			
26	CAP2+	DC/DC Voltage Converter Positive Connection			
27	V 1	Power Supply for LCD Drive $V_1 = 1/9, V_5$			
28	V2	Power Supply for LCD Drive $V_2 = 2/9, V_5$			
29	V3	Power Supply for LCD Drive $V_3 = 7/9, V_5$			
30	V4	Power Supply for LCD Drive $V_4 = 8/9, V_5$			
31	V5	Power Supply for LCD Drive V5, VOUT			
32	VR	Voltage Adjustment Pin			
		Applies voltage between Vcc and V5 using a resistive divider.			
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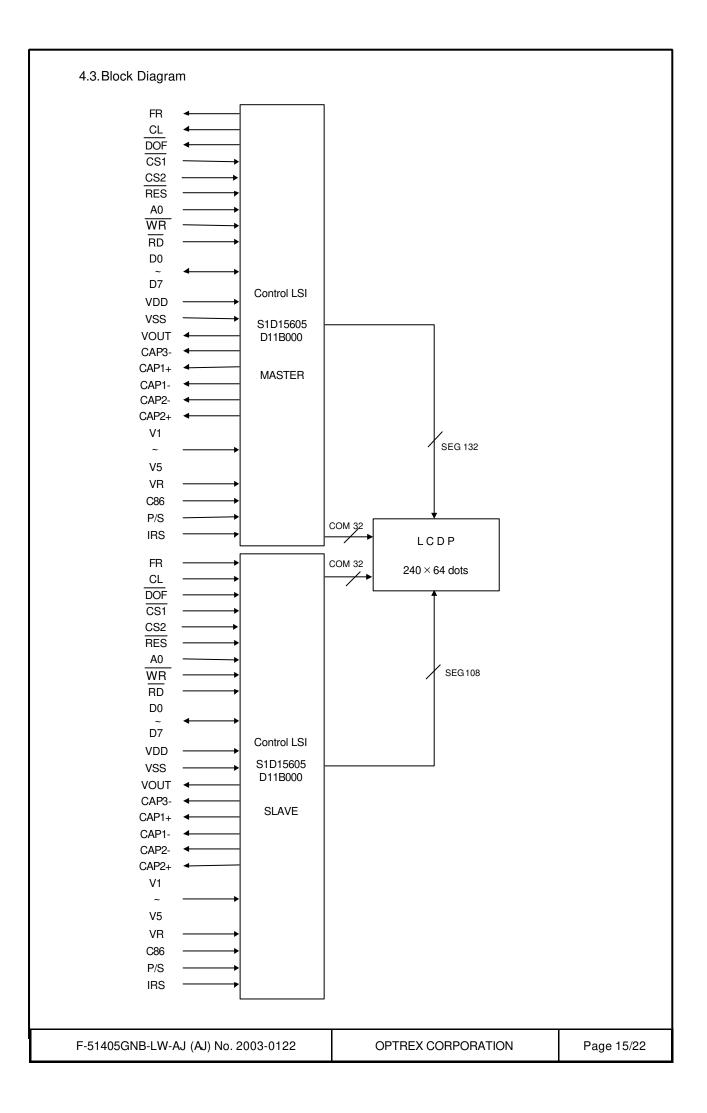
33	C86	Interface Mode Select Signal H : 68 series L : 80 series		
34	P/S	Parallel/Serial Data Select Signal H : Parallel L : Serial		
35	IRS	This terminal selects the resistors for the V5 voltage level adjustment.		
		Master (CN1)		
		IRS="H" :Use the internal resistors		
		IRS="L" :Do not use the internal resistors. The V5 Voltage level is		
		requlated by an external resistive voltage divider attached to the VR		
		terminal.		
		Slave (CN2)		
		IRS=NC (IRS is pulled to VDD.)		
36	NC	Non-connection		
<u>CN3</u>				
No.	Symbol	Function		
1	ANODE	LED Anode Terminal		
2	CATHODE	LED Cathode Terminal		

4.2. Recommendation Example of the circuit

When installing the COG, it is necessary to duly consider the fact that there exists a resistance of the ITO wiring occurring between the driver chip and the externally connected parts (such as capacitors and resistors). By the influence of this resistance, non-conformity may occur with the indications on the liquid crystal display.

Please use circuit by outside power supply.





<u>5.Test</u>

No change on display and in operation under the following test condition.

Conditions: Unless otherwise specified, tests will be conducted under the following condition. Temperature: 20±5°C Humidity : 65±5%RH tests will be not conducted under functioning state.

No.	Parameter	Conditions	Notes
1	High Temperature Operating	50°C±2°C, 96hrs (operation state)	
2	Low Temperature Operating	0°C±2°C, 96hrs (operation state)	1
3	High Temperature Storage	70°C±2°C, 96hrs	2
4	Low Temperature Storage	-20°C±2°C, 96hrs	1,2
5	Damp Proof Test	40°C±2°C,90~95%RH, 96hrs	1,2
6	Vibration Test	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X, Y, Z for each 15 minutes	3
7	Shock Test	To be measured after dropping from 60cm high on the concrete surface in packing state. F E G G G G G G G G	

Note 1 :No dew condensation to be observed.

Note 2 :The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after removed from the test chamber.

Note 3 :Vibration test will be conducted to the product itself without putting it in a container.

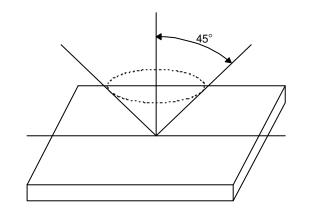
6.Appearance Standards

6.1. Inspection conditions

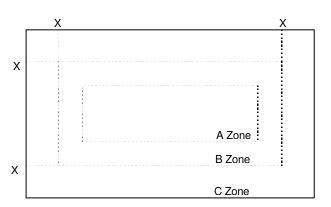
The LCD shall be inspected under 40W white fluorescent light.

The distance between the eyes and the sample shall be more than 30cm.

All directions for inspecting the sample should be within 45° against perpendicular line.



6.2. Definition of applicable Zones



X : Maximum Seal Line

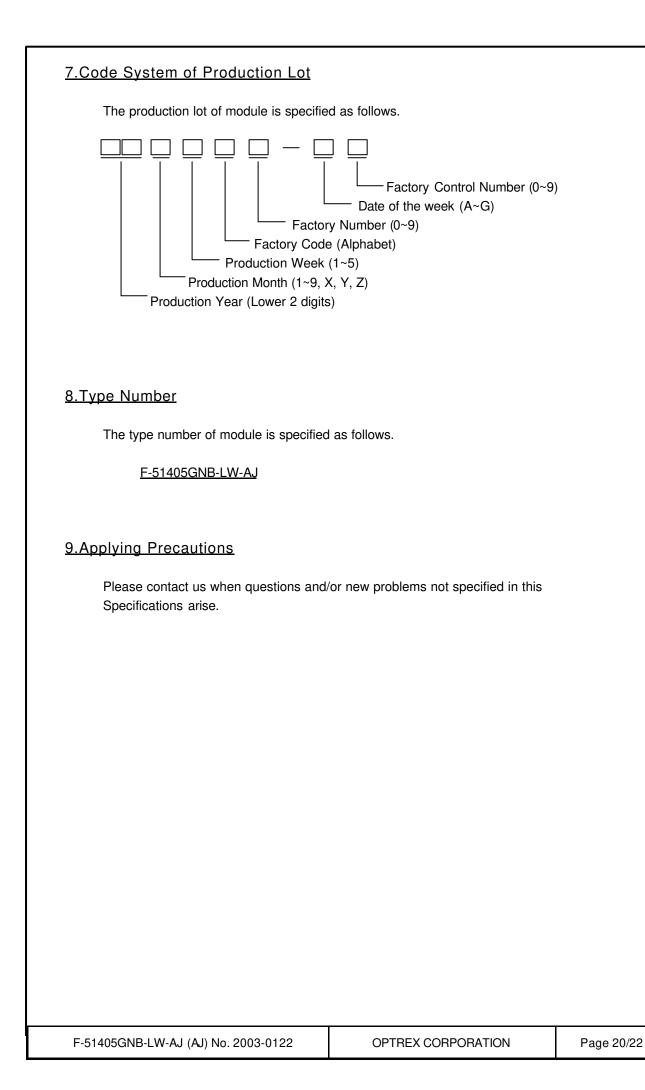
A Zone : Active display area

- B Zone : Out of active display area ~ Maximum seal line
- C Zone : Rest parts

A Zone + B Zone = Validity viewing area

lo.	Parameter	Criteria				
1	Black and	(1) Round Shape				
	White Spots,	Zone		Acceptable Number		
	Foreign Substances	Dimension (mm)		А	В	С
		D ≤ 0.1		*	*	*
		0.1 < D ≤ 0.2		3	5	*
		0.2 < D	$0.2 < D \le 0.25$		3	*
		0.25< D	0.25< D ≤ 0.3		1	*
		0.3 < D		0	0	*
		D = (Long + Short) / 2 * : Disregard				
		(2) Line Shape) 			
		Zone		Acceptable Number		
		X (mm)	Y (mm)	А	В	С
		-	0.03 ≥ W	*	*	*
		2.0 ≥ L	0.05 ≥ W	3	3	*
		1.0 ≥ L	0.1 ≥ W	3	3	*
		- 0.1 < W		In the same way (1)		
		-	Y:Width *	•		
		Total defects s	shall not excee	ed 5.		
2	Air Bubbles					
	(between glass	Zone Dimension (mm)			eptable Num	
	& polarizer)			A	В	С
			D ≤ 0.3		*	*
		0.3 < D ≤ 0.4		3	*	*
			0.4 < D ≤ 0.6		3	*
		0.6 < D		0	0	*
		* : Disregard Total defects shall not excee				

	Parameter	Criteria		
3	The Shape of Dot	(1) Dot Shape (with Dent)		
		0.15≥		
		As per the sketch of left hand.		
		(2) Dot Shape (with Projection)		
		Should not be connected to next dot.		
		(3) Pin Hole $\begin{array}{c} \begin{array}{c} \begin{array}{c} \\ \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} \\ \end{array} \\ $		
		(4) Deformation		
		$(X+Y) / 2 \le 0.2 \text{mm}$		
		Total acceptable number : 1/dot, 5/cell		
4	Deleviser Osvetsker	(Defect number of (4) : 1pc.)		
4	Polarizer Scratches	Not to be conspicuous defects.		
5	Polarizer Dirts	If the stains are removed easily from LCDP surface, the module is not defective.		
6	Complex Foreign Substance Defects	Black spots, line shaped foreign substances or air bubbles between glass & polarizer should be 5pcs maximum in total.		
7	Distance between Different Foreign Substance Defects	$D \le 0.2$: 20mm or more 0.2 < D : 40mm or more		



10.Precautions Relating Product Handling

The Following precautions will guide you in handling our product correctly.

- 1) Liquid crystal display devices
- 1. The liquid crystal display device panel used in the liquid crystal display module is made of plate glass. Avoid any strong mechanical shock. Should the glass break handle it with care.
- 2. The polarizer adhering to the surface of the LCD is made of a soft material. Guard against scratching it.
- 2) Care of the liquid crystal display module against static electricity discharge.
 - 1. When working with the module, be sure to ground your body and any electrical equipment you may be using. We strongly recommend the use of anti static mats (made of rubber), to protect work tables against the hazards of electrical shock.
 - 2. Avoid the use of work clothing made of synthetic fibers. We recommend cotton clothing or other conductivity-treated fibers.
 - 3. Slowly and carefully remove the protective film from the LCD module, since this operation can generate static electricity.
- 3) When the LCD module alone must be stored for long periods of time:
 - 1. Protect the modules from high temperature and humidity.
- 2. Keep the modules out of direct sunlight or direct exposure to ultraviolet rays.
- 3. Protect the modules from excessive external forces.
- 4) Use the module with a power supply that is equipped with an overcurrent protector circuit, since the module is not provided with this protective feature.
- 5) Do not ingest the LCD fluid itself should it leak out of a damaged LCD module. Should hands or clothing come in contact with LCD fluid, wash immediately with soap.
- 6) Conductivity is not guaranteed for models that use metal holders where solder connections between the metal holder and the PCB are not used. Please contact us to discuss appropriate ways to assure conductivity.
- 7) For models which use CFL:
- 1. High voltage of 1000V or greater is applied to the CFL cable connector area. Care should be taken not to touch connection areas to avoid burns.
- 2. Protect CFL cables from rubbing against the unit and thus causing the wire jacket to become worn.
- 3. The use of CFLs for extended periods of time at low temperatures will significantly shorten their service life.
- 8) For models which use touch panels:
- 1. Do not stack up modules since they can be damaged by components on neighboring modules.
- 2. Do not place heavy objects on top of the product. This could cause glass breakage.
- 9) For models which use COG,TAB,or COF:
- 1. The mechanical strength of the product is low since the IC chip faces out unprotected from the rear. Be sure to protect the rear of the IC chip from external forces.
- 2. Given the fact that the rear of the IC chip is left exposed, in order to protect the unit from electrical damage, avoid installation configurations in which the rear of the IC chip runs the risk of making any electrical contact.

10) Models which use flexible cable, heat seal, or TAB:

- 1. In order to maintain reliability, do not touch or hold by the connector area.
- 2. Avoid any bending, pulling, or other excessive force, which can result in broken connections.
- 11) have an adverse effect on connecting parts (LCD panel-TCP / HEAT SEAL / FPC / etc., PCB-TCP / HEAT SEAL / FPC etc., TCP-HEAT SEAL, TCP-FPC, HEAT SEAL-FPC, etc.,) depending on its materials. Please check and evaluate these materials carefully before use.
- 12) In case of acrylic plate is attached to front side of LCD panel, cloudiness (very small cracks) can occur on acrylic plate, being influenced by some components generated from polarizer film..

Please check and evaluate those acrylic materials carefully before use.

11.Warranty

This product has been manufactured to your company's specifications as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in medical devices, nuclear power control equipment, aerospace equipment, fire and security systems, or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required. If the product is to be used in any of the above applications, we will need to enter into a separate product liability agreement.

- 1. We cannot accept responsibility for any defect, which may arise from additional manufacturing of the product (including disassembly and reassembly), after product delivery.
- 2. We cannot accept responsibility for any defect, which may arise after the application of strong external force to the product.
- 3. We cannot accept responsibility for any defect, which may arise due to the application of static electricity after the product has passed your company's acceptance inspection procedures.
- 4. When the product is in CFL models, CFL service life and brightness will vary According to the performance of the inverter used, leaks, etc. We cannot accept responsibility for product performance, reliability, or defect, which may arise.
- 5. We cannot accept responsibility for intellectual property of a third party, which may arise through the application of our product to your assembly with exception to those issues relating directly to the structure or method of manufacturing of our product.
- 6. Optrex will not be held responsible for any quality guarantee issue for defect products judged as Optrex-origin longer than 2 (two) years from Optrex production or 1(one) year from Optrex, Optrex America, Optrex Europe delivery which ever comes later.